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1201.64722

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Li et al.)
Serial No.: 09/662,682)
Filed: September 15, 2000)
For: METAL-ASSISTED CHEMICAL)
ETCH POROUS SILICON)
FORMATION METHOD)
Art Unit: 1765)
Examiner: Vinh, Lan)

I hereby certify that this paper is being facsimile transmitted to the U.S. Patent and Trademark Office on this date.

Nov. 4, 2002

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Date

Registration No. 43,874

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Appr. April 11, 2000

Attorney for Applicant

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AMENDMENT C

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

In response to the Office Action mailed August 2, 2002, please amend the application as follows:

In the Claims:

Please amend claims 1, 11, and 21 to read as follows:

5/10/02

1. (Amended) A method for producing porous silicon, the method

comprising steps of:

depositing a thin discontinuous layer of metal on a Si surface;

forming the porous silicon by etching the Si surface in a HF and oxidant

solution, said etching being conducted without external electrical bias.

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